

# UNISONIC TECHNOLOGIES CO., LTD

## **UF3N30**

**Preliminary** 

## 3A, 300V **N-CHANNEL POWER MOSFET**

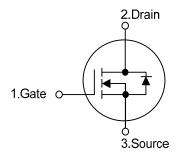
#### DESCRIPTION

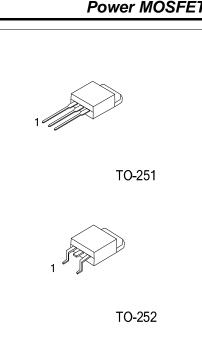
The UTC UF3N30 is an N-channel enhancement mode Power MOSFET using UTC's advanced technology to provide customers with a minimum on-state resistance, low gate charge and superior switching performance.

#### **FEATURES**

- \* R<sub>DS(ON)</sub><2Ω @ V<sub>GS</sub>=10V, I<sub>D</sub>=3A
- \* High switching speed
- \* Typically 4nC low gate charge
- \* 100% avalanche tested







#### **ORDERING INFORMATION**

Ordering Number		Deekege	Pin Assignment			Deaking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
UF3N30L-TM3-R	UF3N30G-TM3-R	TO-251	G	D	S	Tape Reel	
UF3N30L-TN3-R	UF3N30G- TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source

(1) R: Tape Reel
(2) AA3: SOT-223
(3) L: Lead Free, G: Halogen Free

## ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V <sub>DSS</sub>	300	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Continuous Drain Current	Continuous	I <sub>D</sub>	3	А
	Pulsed	I <sub>DM</sub>	12	А
Avalanche Energy		E <sub>AS</sub>	52	mJ
Power Dissipation		PD	50	W
Junction Temperature		ΤJ	+150	°C
Storage Temperature Range		T <sub>STG</sub>	-55~+150	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

### ELECTRICAL CHARACTERISTICS

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						1	-
Drain-Source Breakdown Voltage	е	BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V	300			V
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =300V			1	μA
Gate-Source Leakage Current	Forward		V <sub>GS</sub> =+20V, V <sub>DS</sub> =0V			100	nA
	Reverse		V <sub>GS</sub> =-20V, V <sub>DS</sub> =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V <sub>GS(TH)</sub>	I <sub>D</sub> =250μA			4	V
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =3A			2	Ω
DYNAMIC PARAMETERS							-
Input Capacitance		CISS			200		рF
Output Capacitance		Coss	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1MHz		90		pF
Reverse Transfer Capacitance		C <sub>RSS</sub>			30		pF
SWITCHING PARAMETERS							-
Total Gate Charge		$Q_{G}$			4		nC
Gate to Source Charge		$Q_{GS}$	-V <sub>DD</sub> =50V, I <sub>D</sub> =1.3A, I <sub>G</sub> =100μA, -V <sub>GS</sub> =10V		0.64		nC
Gate to Drain Charge		$Q_{GD}$	VGS=10V		1.6		nC
Turn-ON Delay Time		t <sub>D(ON)</sub>			10		ns
Rise Time		t <sub>R</sub>	$V_{DD}$ =30V, $I_{D}$ =0.5A, $R_{G}$ =25 $\Omega$ ,		50		ns
Turn-OFF Delay Time		t <sub>D(OFF)</sub>	V <sub>GS</sub> =0~10V		30		ns
Fall-Time		t <sub>F</sub>			40		ns
SOURCE- DRAIN DIODE RATII	NGS AND C	CHARACTERI	STICS				-
Maximum Body-Diode Continuous Current		ls				3	Α
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>				12	Α
Drain-Source Diode Forward Voltage		V <sub>SD</sub>	I <sub>S</sub> =0.85A			1.3	V



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